

SPECIFICATIONS

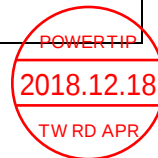
CUSTOMER	:	
SAMPLE CODE	:	SH240320T075-ZEA
MASS PRODUCTION CODE	:	PH240320T075-ZEA
SAMPLE VERSION	:	01
SPECIFICATIONS EDITION	:	004
DRAWING NO. (Ver.)	:	LMD-PH240320T075-ZEA (Ver.001)
PACKAGING NO. (Ver.)	:	PKG-PH240320T075-ZEA (Ver.001)

Customer Approved

Date:

Approved	Checked	Designer
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- ☐ Preliminary specification for design input
☒ Specification for sample approval



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History of Version

[illegible]

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Note : For detailed information please refer to IC data sheet :

Primacy(TFT LCD): Sitrnex ST7789VI(Or Compatible IC)

1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	240 * 3 (RGB) * 320 Dots
LCD Type	Full Viewing Angle , Normally Black , Transmissive type
Screen size(inch)	2.8 inch
Color configuration	RGB-Strip
Backlight Type	White LED B/L
Interface	16-bits 8080 Interface
Other(controller/driver IC)	ST7789VI (Or Compatible IC)
ROHS	THIS PRODUCT CONFORMS THE ROHS OF PTC Detail information please refer website : http://www.powertip.com.tw/news_detail.php?Key=1&clD=1

Note:

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	50.0(W) *69.2 (L) *2.45(H)	mm

LCD Panel

Item	Standard Value	Unit
Active Area	43.2(W) *57.6 (L)	mm
Pixel Size	0.18(W) *0.18 (H)	mm

Note : For detailed information please refer to LCM drawing

1.3 Absolute Maximum Ratings

Module

Item	Symbol	Condition	Min.	Max.	Unit
System Power Supply Voltage	VCC	GND=0	-0.3	4.6	V
Operating Temperature	T _{OP}	-	-20	70	°C
Storage Temperature	T _{ST}	-	-30	80	°C
Storage Humidity	H _D	T _a ≤ 60 °C	10	90	%RH

1.4 DC Electrical Characteristics

Module

GND = 0V, T_a = 25°C

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Power Supply Voltage	VCC	-	-	2.8	-	V
Input H/L Level Voltage	V _{IH}	-	0.7VCC	-	VCC	V
	V _{IL}	-	GND	-	0.3VCC	V
Supply Current	I _{dd}	VCC =2.8 V Pattern=Picture	-	7	-	mA
		VCC =2.8 V Pattern= White *1	-	10	15	mA

Note1:Maximum current display

1.5 Optical Characteristics

TFT LCD Module

VCC = 2.8 V, Ta=25 °C

Item	Symbol		Condition	Min.	Typ.	Max.	unit	
Response time	Tr+Tf		Ta = 25 °C $\theta X, \theta Y = 0^\circ$	-	30	40	ms	Note 2
Viewing angle	Top	$\theta Y+$	CR ≥ 10	-	80	-	Deg.	Note 4
	Bottom	$\theta Y-$		-	80	-		
	Left	$\theta X-$		-	80	-		
	Right	$\theta X+$		-	80	-		
Contrast ratio		CR	Ta = 25 °C $\theta X, \theta Y = 0^\circ$	650	800	-	-	Note 3
Color of CIE Coordinate (With B/L)	White	X		0.25	0.30	0.35		Note1
		Y		0.29	0.34	0.39		
	Red	X		0.59	0.64	0.69		
		Y		0.28	0.33	0.38		
	Green	X		0.26	0.31	0.36		
		Y		0.57	0.62	0.67		
	Blue	X		0.09	0.14	0.19		
		Y		0.00	0.05	0.10		
Average Brightness Pattern=white display (With LCD)*1	IF		IF= 80 mA	300	350	-	cd/m ²	Note1
Uniformity (With LCD)*2	ΔB		IF=80 mA	70	-	-	%	Note1

Note 1:

*1 : $\Delta B = B(\min) / B(\max) * 100\%$

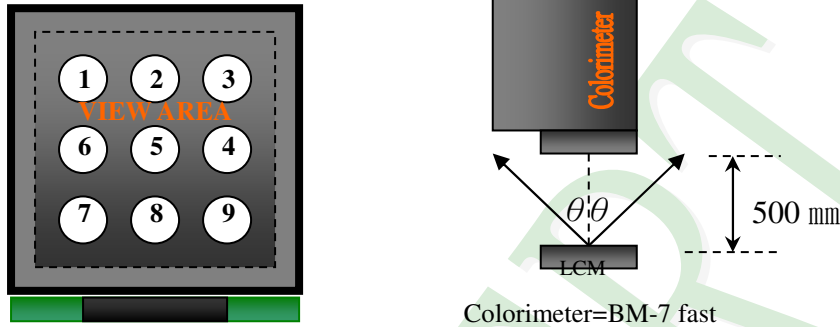
*2 : Measurement Condition for Optical Characteristics:

a : Environment: $25^{\circ}\text{C} \pm 5^{\circ}\text{C}$ / $60 \pm 20\%$ R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.

b : Measurement Distance: 500 ± 50 mm , ($\theta = 0^{\circ}$)

c : Equipment: TOPCON BM-7 fast , (field 1°) , after 10 minutes operation.

d : The uncertainty of the C.I.E coordinate measurement ± 0.01 , Average Brightness $\pm 4\%$



To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

Note2: Definition of response time:

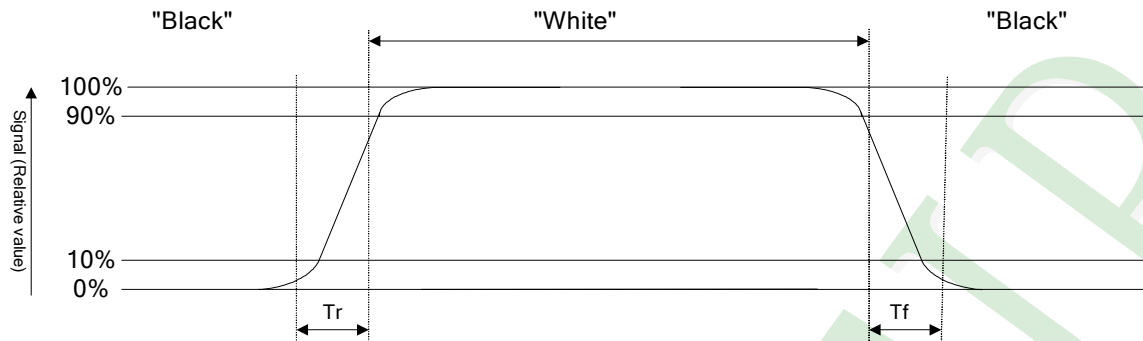
The output signals of photo detector are measured when the input signals are changed from "black" to "white"(falling time) and from "white" to "black"(rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

Refer to figure as below:

Normally White



Normally Black



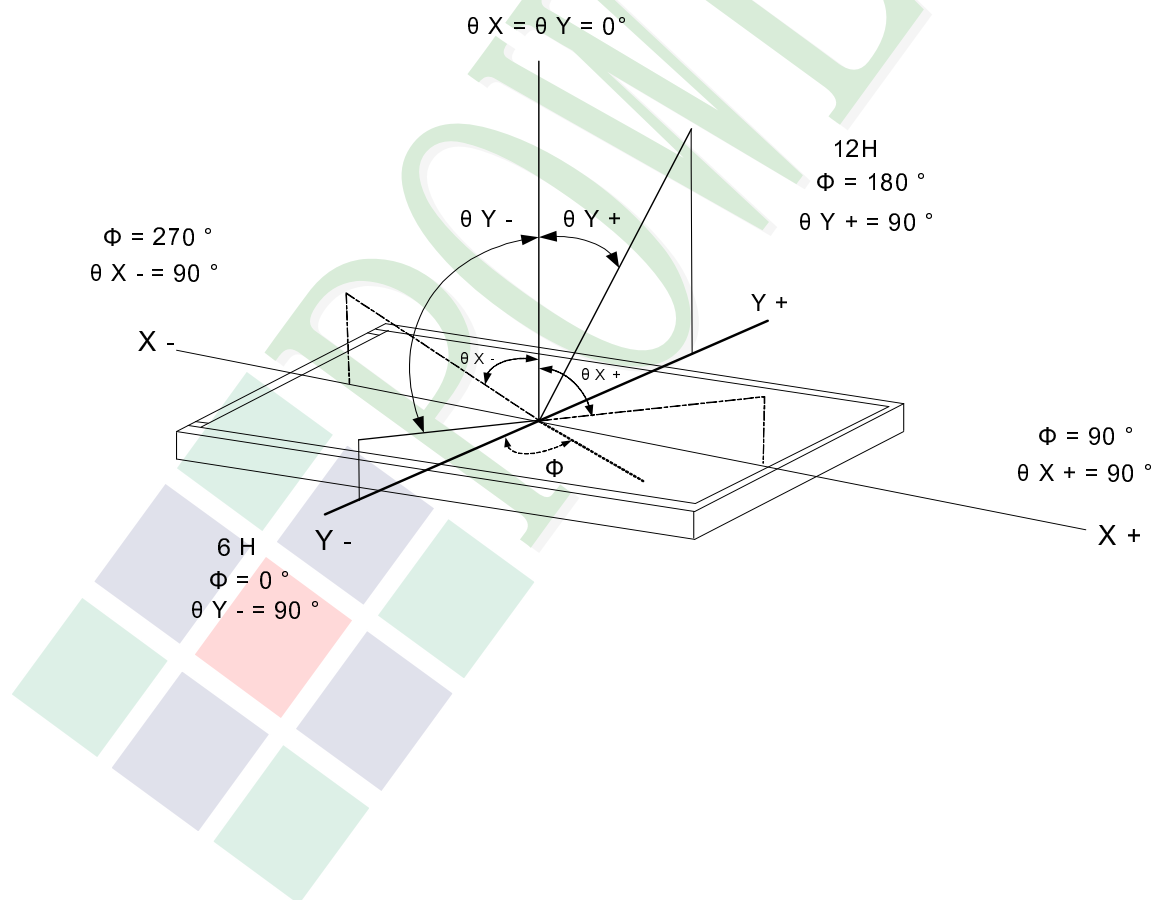
Note3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

$$\text{Contrast ratio (CR)} = \frac{\text{Photo detector output when LCD is at "White" state}}{\text{Photo detector output when LCD is at "Black" state}}$$

Note4: Definition of viewing angle:

Refer to figure as below:



1.6 Backlight Characteristics

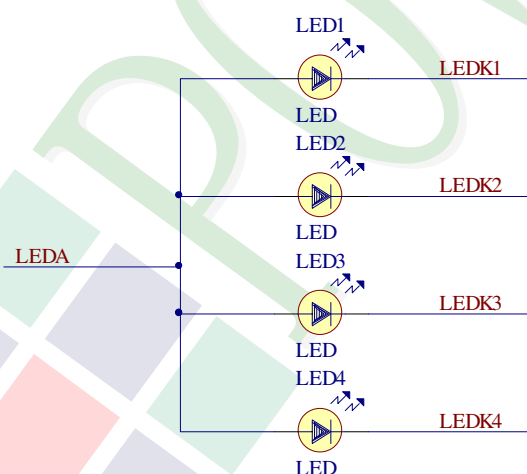
Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
LED Forward Current	IF	Ta =25°C	-	30/Per LED	mA
LED Reverse Voltage	VR		-	5	V
Power consumption	Pd			288	mW

Electrical / Optical Characteristics

Electrical / Optical Characteristics						
Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage	VF	If= 80mA	2.8	3.3	3.6	
Average Brightness (Without LCD)	IV		8500	10000	11500	cd/m ²
CIE Color Coordinate (Without LCD)	X			0.28		-
	Y			0.28		
Color	White					

B/L Internal Circuit Diagram:



Other Description

Item	Conditions	Description
Life Time	Ta =25°C IF= 80mA	50,000 hrs

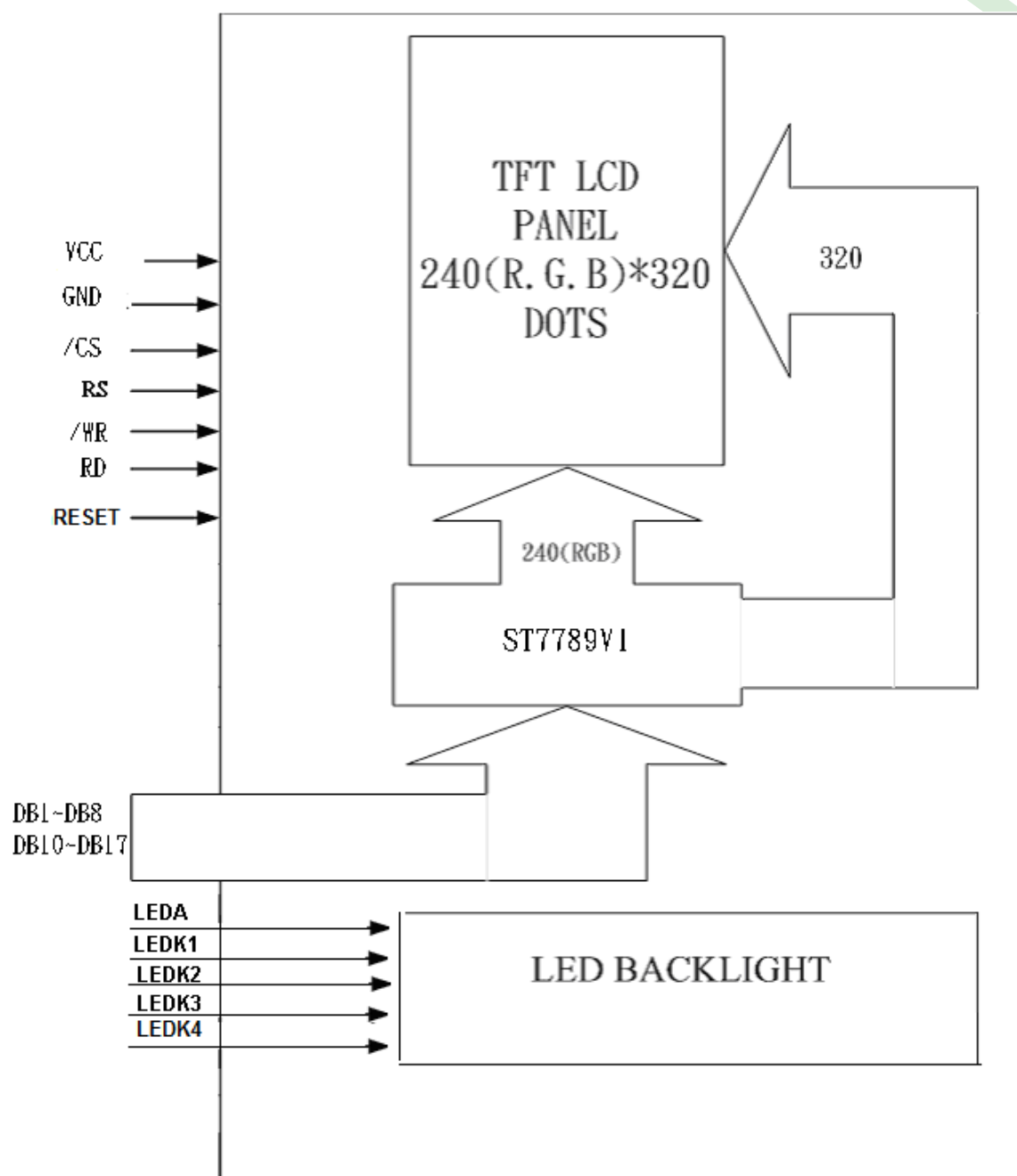
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram



2.2 Interface Pin Description

Pin No.	Symbol	Function
1	DB1	Bi-directional data bus
2	DB2	Bi-directional data bus
3	DB3	Bi-directional data bus
4	DB4	Bi-directional data bus
5	GND	Signal ground.(0V)
6	VCC	Power supply for the internal logic circuit
7	/CS	Chip select signal , Active at "L"
8	RS	When RS = 0: Command. When RS = 1: Display data
9	/WR	Write signal input , active at Low.
10	RD	Read data at the rising edge
11	NC	No connect
12	XR/X+	No connect
13	YU/Y+	No connect
14	XL/X-	No connect
15	YD/Y-	No connect
16	LEDA	Power supply for LED Backlight Anode input
17	LEDK1	Power supply for LED Backlight Cathode input
18	LEDK2	Power supply for LED Backlight Cathode input
19	LEDK3	Power supply for LED Backlight Cathode input
20	LEDK4	Power supply for LED Backlight Cathode input
21	NC	No connect
22	DB5	Bi-directional data bus
23	DB10	Bi-directional data bus
24	DB11	Bi-directional data bus
25	DB12	Bi-directional data bus

Pin No.	Symbol	Function
26	DB13	Bi-directional data bus
27	DB14	Bi-directional data bus
28	DB15	Bi-directional data bus
29	DB16	Bi-directional data bus
30	DB17	Bi-directional data bus
31	RESET	Reset input pin for TFT LCD. When RESET is "L", initialization is executed
32	VCC	Power supply for the internal logic circuit.
33	VCC	Power supply for the internal logic circuit.
34	GND	Signal ground.(0V)
35	DB6	Bi-directional data bus
36	DB7	Bi-directional data bus
37	DB8	Bi-directional data bus

2.2.1 Application Notes:

Interface

1	DB1
2	DB2
3	DB3
4	DB4
5	GND
6	VDD
7	CS
8	RS
9	WR
10	RD
11	×
12	×
13	×
14	×
15	×
16	×
16	LEDA
17	LEDK1
18	LEDK2
19	LEDK3
20	LEDK4
21	×
22	×
22	DB5
23	DB10
24	DB11
25	DB12
26	DB13
27	DB14
28	DB15
29	DB16
30	DB17
31	RESET
32	VDD
33	VDD
34	GND
35	DB6
36	DB7
37	DB8

2.2.2 Refer Initial code:

```
void Initial_Main(void)                                // For ST7789VI

{

    WriteCOM_Main(0x00,0x11); //exit sleep
    Delay(120);
    WriteCOM_Main(0x00,0x36); //Memory access Control
    WriteDAT_Main(0x00,0x00);

    WriteCOM_Main(0x00,0x3A); //Interface pixel format
    WriteDAT_Main(0x00,0x05);

    //-----ST7789VI Frame rate setting-----//
    WriteCOM_Main(0x00,0xB2);
    WriteDAT_Main(0x00,0x0c);
    WriteDAT_Main(0x00,0x0c);
    WriteDAT_Main(0x00,0x00);
    WriteDAT_Main(0x00,0x33);
    WriteDAT_Main(0x00,0x33);

    WriteCOM_Main(0x00,0xB7);
    WriteDAT_Main(0x00,0x35);
    //-----ST7789VI Power setting-----//

    WriteCOM_Main(0x00,0xbb); //VCOMS Setting
    WriteDAT_Main(0x00,0x3D);

    WriteCOM_Main(0x00,0xc0);
    WriteDAT_Main(0x00,0x2c);

    WriteCOM_Main(0x00,0xc2);
    WriteDAT_Main(0x00,0x01);

    WriteCOM_Main(0x00,0xc3);
    WriteDAT_Main(0x00,0x0B);
```

```
WriteCOM_Main(0x00,0xc4);  
WriteDAT_Main(0x00,0x20);
```

```
WriteCOM_Main(0x00,0xc6);  
WriteDAT_Main(0x00,0x0f);
```

```
WriteCOM_Main(0x00,0xd0);  
WriteDAT_Main(0x00,0xa4);  
WriteDAT_Main(0x00,0xa1);
```

```
WriteCOM_Main(0x00,0x21);
```

```
//-----set gamma-----
```

```
WriteCOM_Main(0x00,0xe0); //set gamma
```

```
WriteDAT_Main(0x00,0x70);
```

```
WriteDAT_Main(0x00,0x04);
```

```
WriteDAT_Main(0x00,0x08);
```

```
WriteDAT_Main(0x00,0x07);
```

```
WriteDAT_Main(0x00,0x06);
```

```
WriteDAT_Main(0x00,0x04);
```

```
WriteDAT_Main(0x00,0x21);
```

```
WriteDAT_Main(0x00,0x42);
```

```
WriteDAT_Main(0x00,0x38);
```

```
WriteDAT_Main(0x00,0x37);
```

```
WriteDAT_Main(0x00,0x13);
```

```
WriteDAT_Main(0x00,0x13);
```

```
WriteDAT_Main(0x00,0x25);
```

```
WriteDAT_Main(0x00,0x2C);
```

```
WriteCOM_Main(0x00,0xe1); //set gamma
```

```
WriteDAT_Main(0x00,0x70);
```

```
WriteDAT_Main(0x00,0x00);
```

```
WriteDAT_Main(0x00,0x02);
```

```
WriteDAT_Main(0x00,0x08);
```

```
WriteDAT_Main(0x00,0x07);
```

```
WriteDAT_Main(0x00,0x22);
```

```
WriteDAT_Main(0x00,0x1F);
```

```
WriteDAT_Main(0x00,0x23);
```

```
WriteDAT_Main(0x00,0x39);
```

```
WriteDAT_Main(0x00,0x28);
```

```
WriteDAT_Main(0x00,0x14);
```

```
WriteDAT_Main(0x00,0x15);
```

```
WriteDAT_Main(0x00,0x26);
```

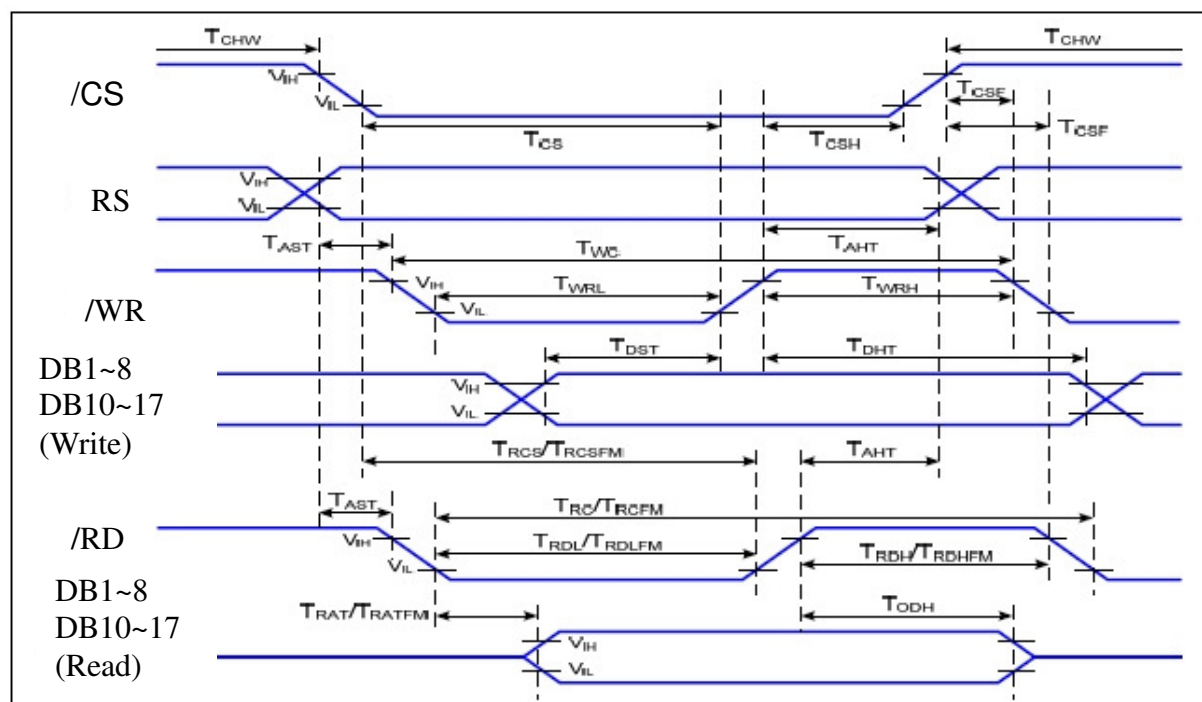
```
WriteDAT_Main(0x00,0x2D);
```

```
WriteCOM_Main(0x00,0x29);//Display on
```

```
}
```

2.3 Timing Characteristics

Parallel 16-Bit RGB Interface Timing

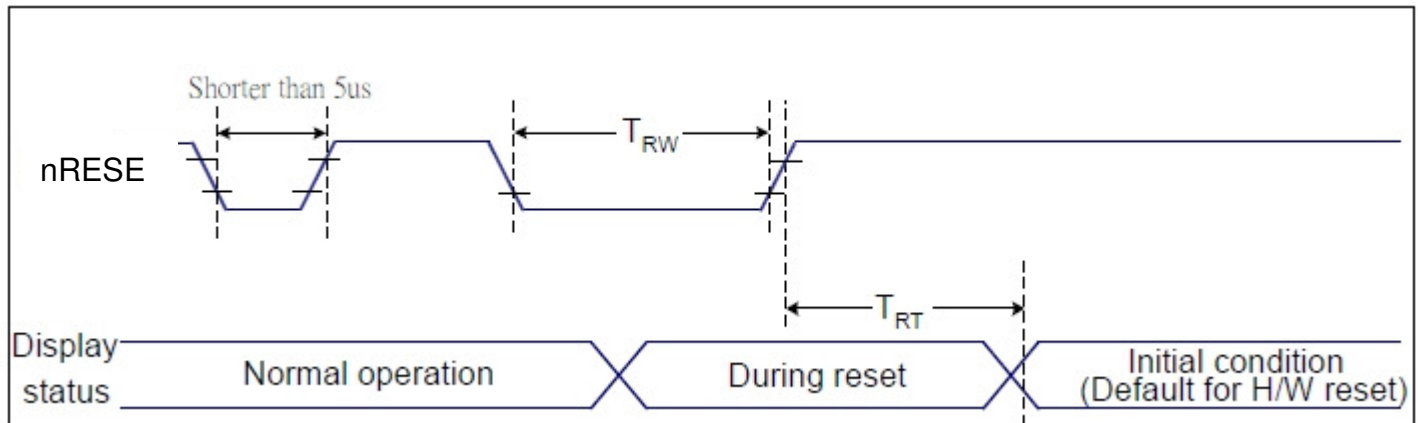


VCC= 2.8V, Ta=25°C

Signal	Symbol	Parameter	Min	Max	Unit
RS	TAST	Address Setup time	0	-	ns
	TAHT	Address Hold time(Write/Read)	10	-	ns
/CS	TCHW	CS "H" pulse width	0	-	ns
	TCS	Chip select Setup time (Write)	15	-	
	TRCS	Chip Select setup time (Read ID)	45		ns
	TRCSFM	Chip select Setup time (Read FM)	355	-	ns
	TCSF	Chip select wait time(Write/Read)	10	-	ns
	TCSH	Chip select hold time	10	-	ns
/WR	tWC	Write Cycle	66	-	ns
	tWRH	Control pulse "H" duration	15	-	ns
	tWRL	Control pulse "L" duration	15	-	ns
RD(FM)	tRCFM	Read Cycle(FM)	450	-	ns
	tRDHFM	Read Control H duration (FM)	90	-	ns
	tRDLFM	Read Control L duration (FM)	355	-	ns
RD(ID)	trc	Read Cycle(ID)	160		ns
	trdh	Read Control pulse H duration	90		ns
	trdl	Read Control pulse L duration	45		ns

Signal	Symbol	Parameter	Min	Max	Unit
DB1~DB8	tDST	Write Data setup time	10		ns
DB10~DB17	tRAT	Read access time		40	ns
	tRATFM	Read access time	-	340	ns
	tODH	Read Output disable time	20	80	ns

LCD Reset



Signal	Symbol	Parameter	Min.	Max.	Unit
nRESET	TRW	Reset pulse duration	10	-	us
	TRT	Reset cancel	-	5 (Note1,5)	ms
			-	120 (Note1,6,7)	ms

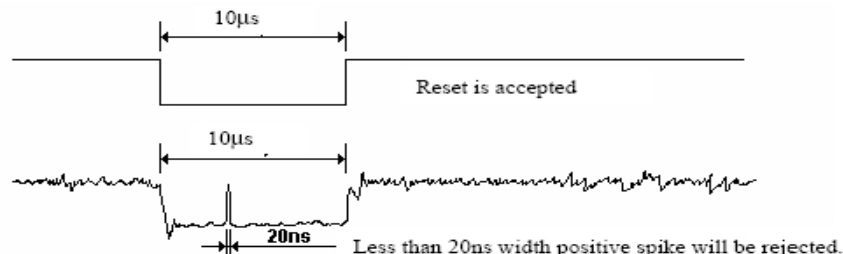
Note 1: The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NV memory to registers. This loading is done every time when there is HW reset cancel time (t_{RT}) within 5 ms after a rising edge of RESX.

Note 2: Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below: -

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 10us	Reset
Between 5us and 10us	Reset starts

Note 3: During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out -mode. The display remains the blank state in Sleep In -mode.) And then return to Default condition for Hardware Reset.

Note 4: Spike Rejection also applies during a valid reset pulse as shown below:



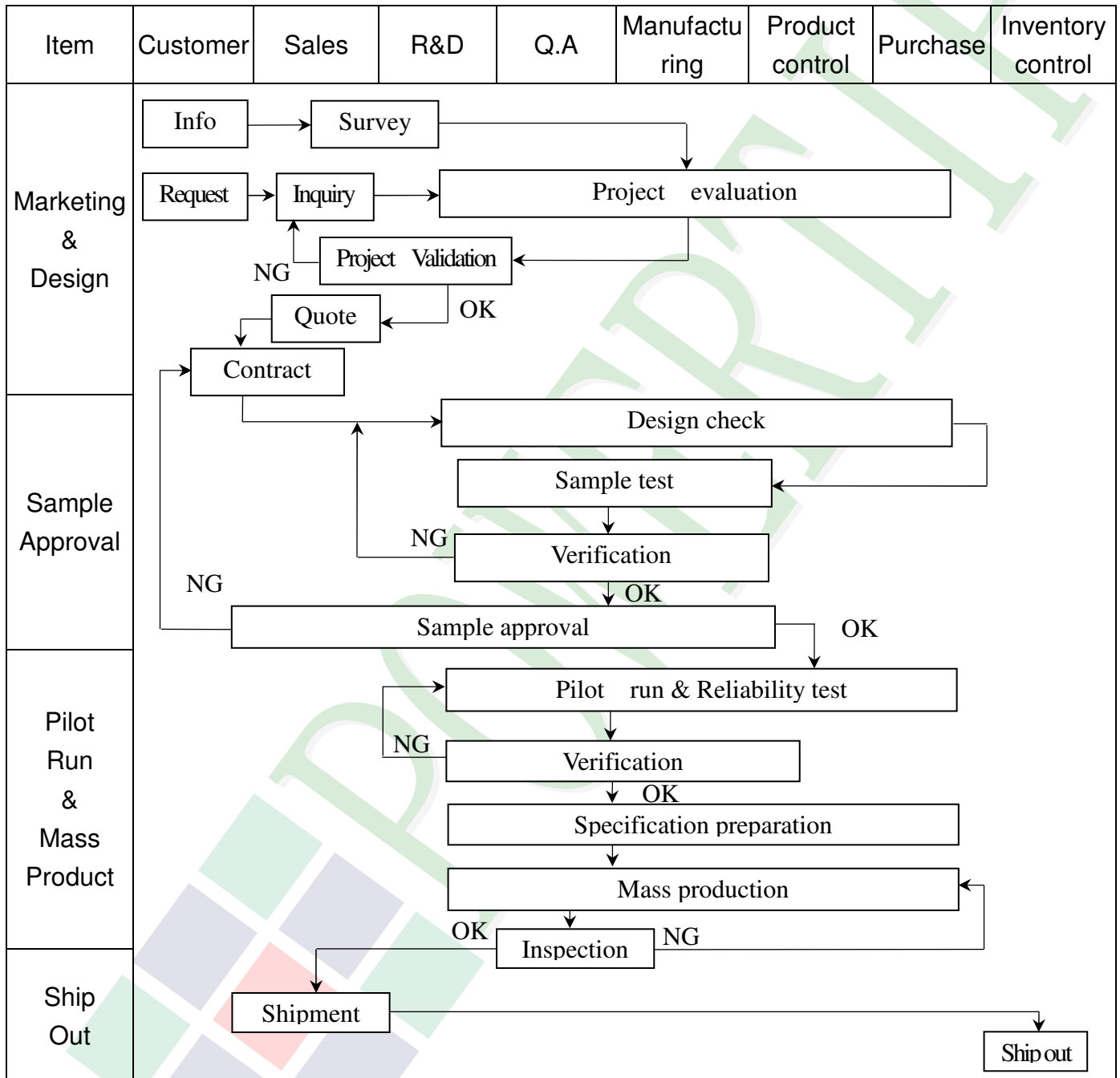
Note 5: When Reset applied during Sleep In Mode.

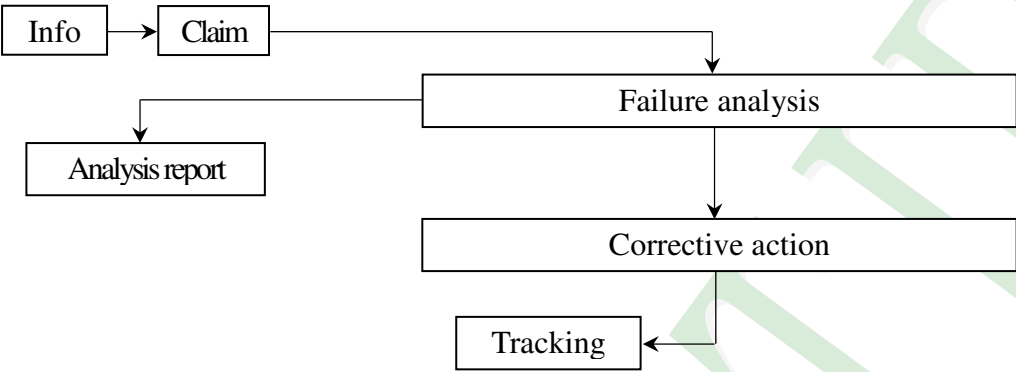
Note 6: When Reset applied during Sleep Out Mode.

Note 7: It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart



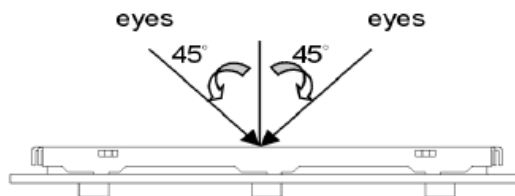
Item	Customer	Sales	R&D	Q.A	Manufacturing	Product control	Purchase	Inventory control
Sales Service	 <pre> graph TD Info[Info] --> Claim[Claim] Claim --> Analysis[Analysis report] Claim --> Failure[Failure analysis] Failure --> Corrective[Corrective action] Corrective --> Tracking[Tracking] </pre>							
Q.A Activity	1. ISO 9001 Maintenance Activities 3. Equipment calibration 5. Standardization Management				2. Process improvement proposal 4. Education And Training Activities			

3.2. Inspection Specification

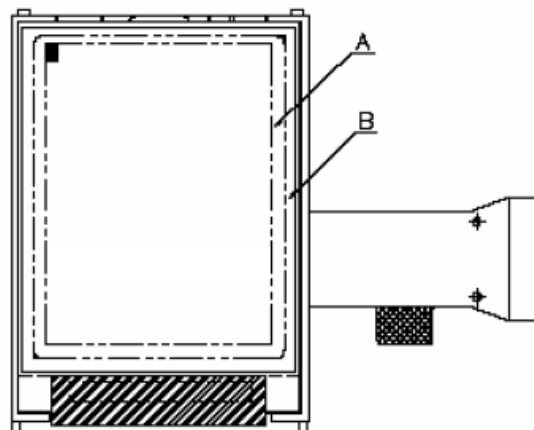
- ◆ **Scope** : The document shall be applied to TFT-LCD Module for less than 3.5" (Ver.B01).
- ◆ **Inspection Standard** : MIL-STD-105E Table Normal Inspection Single Sampling Level II.
- ◆ **Equipment** : Gauge、MIL-STD、Powertip Tester、Sample
- ◆ **Defect Level** : Major Defect AQL : 0.4 ; Minor Defect AQL : 1.5
- ◆ **OUT Going Defect Level** : Sampling.
- ◆ **Standard of the product appearance test** :

a. Manner of appearance test :

- (1). The test best be under 20W×2 fluorescent light , and distance of view must be at 30 cm.
- (2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area : viewing area

B area : Outside of viewing area

(4). Standard of inspection : (Unit : mm)



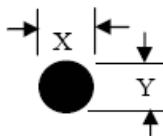
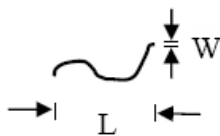
◆ Specification For TFT-LCD Module Less Than 3.5" :

(Ver.B01)

NO	Item	Criterion	Level												
01	Product condition	1. 1 The part number is inconsistent with work order of production.	Major												
		1. 2 Mixed product types.	Major												
		1. 3 Assembled in inverse direction.	Major												
02	Quantity	2. 1 The quantity is inconsistent with work order of production.	Major												
03	Outline dimension	3. 1 Product dimension and structure must conform to structure diagram.	Major												
04	Electrical Testing	4. 1 Missing line character and icon.	Major												
		4. 2 No function or no display.	Major												
		4. 3 Display malfunction.	Major												
		4. 4 LCD viewing angle defect.	Major												
		4. 5 Current consumption exceeds product specifications.	Major												
05	Dot defect (Bright dot 、Dark dot) On -display	<table><thead><tr><th colspan="2">Item</th><th>Acceptance (Q'ty)</th></tr></thead><tbody><tr><td rowspan="4">Dot Defect</td><td>Bright Dot</td><td>≤ 2</td></tr><tr><td>Dark Dot</td><td>≤ 3</td></tr><tr><td>Joint Dot</td><td>≤ 2</td></tr><tr><td>Total</td><td>≤ 3</td></tr></tbody></table> 5. 1 Inspection pattern : full white , full black , Red , Green and blue screens. 5. 2 It is defined as dot defect if defect area $>1/2$ dot. 5. 3 The distance between two dot defect ≥ 5 mm.	Item		Acceptance (Q'ty)	Dot Defect	Bright Dot	≤ 2	Dark Dot	≤ 3	Joint Dot	≤ 2	Total	≤ 3	Minor
Item		Acceptance (Q'ty)													
Dot Defect	Bright Dot	≤ 2													
	Dark Dot	≤ 3													
	Joint Dot	≤ 2													
	Total	≤ 3													

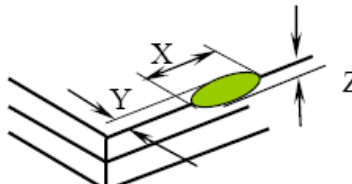
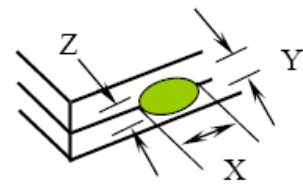
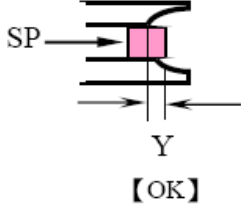
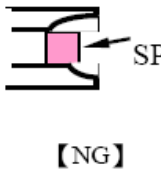
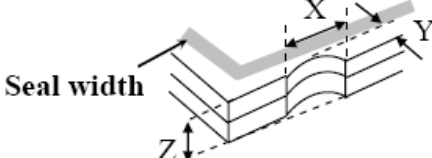
◆ Specification For TFT-LCD Module Less Than 3.5" :

(Ver.B01)

NO	Item	Criterion	Level																																					
06	Black or white dot、scratch、contamination Round type  $\Phi=(x+y) / 2$ Line type 	6. 1 Round type (Non-display or display) : <table><tr><th rowspan="2">Dimension (diameter : Φ)</th><th colspan="2">Acceptance (Q'ty)</th></tr><tr><th>A area</th><th>B area</th></tr><tr><td>$\Phi \leq 0.15$</td><td>Ignore</td><td rowspan="5">Ignore</td></tr><tr><td>$0.15 < \Phi \leq 0.20$</td><td>2</td></tr><tr><td>$0.20 < \Phi \leq 0.30$</td><td>2</td></tr><tr><td>$\Phi > 0.30$</td><td>0</td></tr><tr><td>Total</td><td>3</td></tr></table> 6. 2 Line type(Non-display or display) : <table><tr><th colspan="2">Dimension</th><th colspan="2">Acceptance (Q'ty)</th></tr><tr><th>Length (L)</th><th>Width (W)</th><th>A area</th><th>B area</th></tr><tr><td>---</td><td>$W \leq 0.03$</td><td>Ignore</td><td rowspan="4">Ignore</td></tr><tr><td>$L \leq 5.0$</td><td>$0.03 < W \leq 0.05$</td><td>3</td></tr><tr><td>---</td><td>$W > 0.05$</td><td>As round type</td></tr><tr><td colspan="2">Total</td><td>3</td></tr></table>	Dimension (diameter : Φ)	Acceptance (Q'ty)		A area	B area	$\Phi \leq 0.15$	Ignore	Ignore	$0.15 < \Phi \leq 0.20$	2	$0.20 < \Phi \leq 0.30$	2	$\Phi > 0.30$	0	Total	3	Dimension		Acceptance (Q'ty)		Length (L)	Width (W)	A area	B area	---	$W \leq 0.03$	Ignore	Ignore	$L \leq 5.0$	$0.03 < W \leq 0.05$	3	---	$W > 0.05$	As round type	Total		3	Minor
	Dimension (diameter : Φ)	Acceptance (Q'ty)																																						
A area		B area																																						
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07	Polarizer Bubble	<table><tr><th rowspan="2">Dimension (diameter : Φ)</th><th colspan="2">Acceptance (Q'ty)</th></tr><tr><th>A area</th><th>B area</th></tr><tr><td>$\Phi \leq 0.20$</td><td>Ignore</td><td rowspan="4">Ignore</td></tr><tr><td>$0.20 < \Phi \leq 0.50$</td><td>3</td></tr><tr><td>$\Phi > 0.50$</td><td>0</td></tr><tr><td>Total</td><td>3</td></tr></table>	Dimension (diameter : Φ)	Acceptance (Q'ty)		A area	B area	$\Phi \leq 0.20$	Ignore	Ignore	$0.20 < \Phi \leq 0.50$	3	$\Phi > 0.50$	0	Total	3	Minor																							
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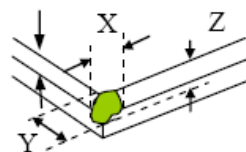
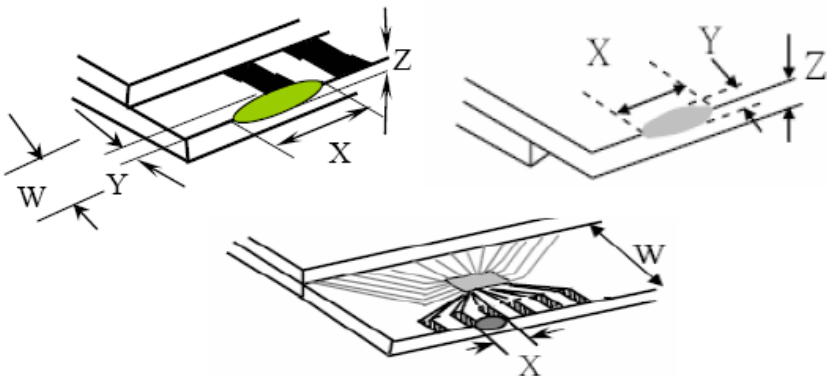
◆Specification For TFT-LCD Module Less Than 3.5" :

(Ver.B01)

NO	Item	Criterion	Level						
08	The crack of glass	Symbols : X : The length of crack Z : The thickness of crack t : The thickness of glass Y : The width of crack. W : terminal length a : LCD side length	Minor						
		8.1 General glass chip : 8.1.1 Chip on panel surface and crack between panels:    【OK】  【NG】  <table><thead><tr><th>X</th><th>Y</th><th>Z</th></tr></thead><tbody><tr><td>$\leq a$</td><td>Crack can't enter viewing area</td><td>$\leq 1/2 t$</td></tr><tr><td>$\leq a$</td><td>Crack can't exceed the half of SP width.</td><td>$1/2 t < Z \leq 2 t$</td></tr></tbody></table>		X	Y	Z	$\leq a$	Crack can't enter viewing area	$\leq 1/2 t$
X	Y	Z							
$\leq a$	Crack can't enter viewing area	$\leq 1/2 t$							
$\leq a$	Crack can't exceed the half of SP width.	$1/2 t < Z \leq 2 t$							

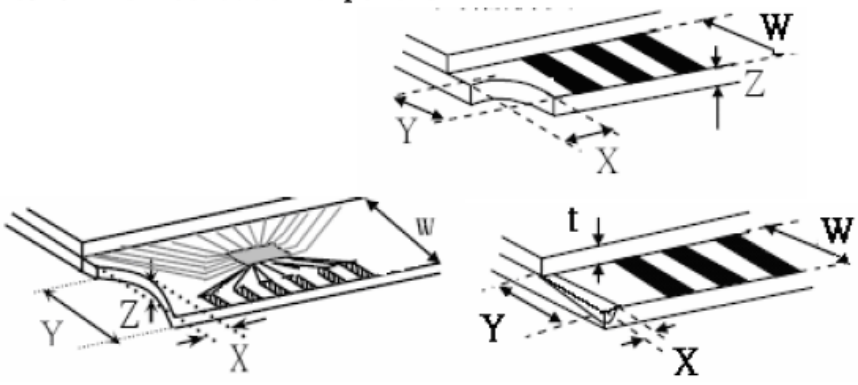
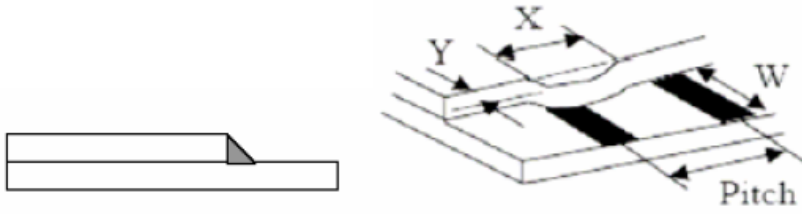
◆Specification For TFT-LCD Module Less Than 3.5" :

(Ver.B01)

NO	Item	Criterion	Level												
08	The crack of glass	Symbols : X : The length of crack Z : The thickness of crack t : The thickness of glass Y : The width of crack. W : terminal length a : LCD side length	Minor												
		8.1.2 Corner crack :  <table><tr><th>X</th><th>Y</th><th>Z</th></tr><tr><td>$\leq 1/5 a$</td><td>Crack can't enter viewing area</td><td>$Z \leq 1/2 t$</td></tr><tr><td>$\leq 1/5 a$</td><td>Crack can't exceed the half of SP width.</td><td>$1/2 t < Z \leq 2 t$</td></tr></table>		X	Y	Z	$\leq 1/5 a$	Crack can't enter viewing area	$Z \leq 1/2 t$	$\leq 1/5 a$	Crack can't exceed the half of SP width.	$1/2 t < Z \leq 2 t$			
X	Y	Z													
$\leq 1/5 a$	Crack can't enter viewing area	$Z \leq 1/2 t$													
$\leq 1/5 a$	Crack can't exceed the half of SP width.	$1/2 t < Z \leq 2 t$													
		8.2 Protrusion over terminal : 8.2.1 Chip on electrode pad :  <table><tr><th></th><th>X</th><th>Y</th><th>Z</th></tr><tr><td>Front</td><td>$\leq a$</td><td>$\leq 1/2 W$</td><td>$\leq t$</td></tr><tr><td>Back</td><td>$\leq a$</td><td>$\leq W$</td><td>$\leq 1/2 t$</td></tr></table>		X	Y	Z	Front	$\leq a$	$\leq 1/2 W$	$\leq t$	Back	$\leq a$	$\leq W$	$\leq 1/2 t$	
	X	Y	Z												
Front	$\leq a$	$\leq 1/2 W$	$\leq t$												
Back	$\leq a$	$\leq W$	$\leq 1/2 t$												

◆Specification For TFT-LCD Module Less Than 3.5" :

(Ver.B01)

NO	Item	Criterion	Level												
08	The crack of glass	Symbols : X : The length of crack Z : The thickness of crack t : The thickness of glass Y : The width of crack. W : terminal length a : LCD side length 8.2.2 Non-conductive portion :  <table> <tr> <td>X</td> <td>Y</td> <td>Z</td> </tr> <tr> <td>$\leq 1/3 a$</td> <td>$\leq W$</td> <td>$\leq t$</td> </tr> </table> ☉ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. 8.2.3 Glass remain :  <table> <tr> <td>X</td> <td>Y</td> <td>Z</td> </tr> <tr> <td>$\leq a$</td> <td>$\leq 1/3 W$</td> <td>$\leq t$</td> </tr> </table>	X	Y	Z	$\leq 1/3 a$	$\leq W$	$\leq t$	X	Y	Z	$\leq a$	$\leq 1/3 W$	$\leq t$	Minor
		X	Y	Z											
$\leq 1/3 a$	$\leq W$	$\leq t$													
X	Y	Z													
$\leq a$	$\leq 1/3 W$	$\leq t$													

◆Specification For TFT-LCD Module Less Than 3.5" :
(Ver.B01)

NO	Item	Criterion	Level
09	Backlight elements	9.1 Backlight can't work normally.	Major
		9.2 Backlight doesn't light or color is wrong.	Major
		9.3 Illumination source flickers when lit.	Major
10	General appearance	10.1 Pin type 、 quantity 、 dimension must match type in structure diagram.	Major
		10.2 No short circuits in components on PCB or FPC .	Major
		10.3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts , missing parts or excess parts.	Major
		10.4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10.5 The folding and peeled off in polarizer are not acceptable.	Minor
		10.6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≤ 1.5 mm.	Minor

4. RELIABILITY TEST

4.1 Reliability Test Condition

(Ver.B01)

NO.	TEST ITEM	TEST CONDITION	
1	High Temperature Storage Test	Keep in 80 ±5℃ 240 hrs	
2	Low Temperature Storage Test	Keep in -30 ±5℃ 240 hrs	
3	High Temperature / High Humidity Storage Test	Keep in 60 ℃ / 90% R.H duration for 240 hrs (Excluding the polarizer)	
4	Temperature Cycling Storage Test	-30℃ → +25℃ → 80℃ → +25℃ (30mins) (5mins) (30mins) (5mins) ← 10 Cycle →	
5	ESD Test	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/-	Contact Discharge: Apply 250 V with 5 times discharge for each polarity +/-
		1. Temperature ambience : 15℃ ~35℃ 2. Humidity relative : 30% ~60% 3. Energy Storage Capacitance(Cs+Cd) : 150pF±10% 4. Discharge Resistance(Rd) : 330Ω±10% 5. Discharge, mode of operation : Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication : ±5%)	
6	Vibration Test (Packaged)	1. Sine wave 10~55 Hz frequency (1 min/sweep) 2. The amplitude of vibration :1.5 mm 3. Each direction (X、Y、Z) duration for 2 Hrs	
7	Drop Test (Packaged)		
		Packing Weight (Kg)	Drop Height (cm)
		0 ~ 45.4	122
		45.4 ~ 90.8	76
		90.8 ~ 454	61
Over 454	46		
		Drop Direction :※1 corner / 3 edges / 6 sides each 1time	

◎Result Evaluation Criteria :

Under the display quality test conditions with normal operations with normal operation state.
Do not change these conditions as such changes may affect practical display function.
(Normal operation state)

Temperature : $+20 \sim 30^{\circ}\text{C}$

Humidity : $50 \sim 70\%$

Atmospheric pressure : $86 \sim 106\text{Kpa}$

5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks , be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes , please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands , this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is $320\pm 10^{\circ}\text{C}$ and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM .

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is $25^{\circ}\text{C} \pm 5^{\circ}\text{C}$ and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush , shake , or jolt the module.

5.4 TERMS OF WARRANTY

- 5.4.1 Applicable warrant period
The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility
This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment , we cannot take responsibility if the product is used in nuclear power control equipment , aerospace equipment , fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.

Ver.001		LCM包裝規格書 LCM Packaging Specifications (For Tray)	Approve	Check	Contact
Documents NO.	PKG-PH240320T075-ZEA		Jimmy	Tina	Clare

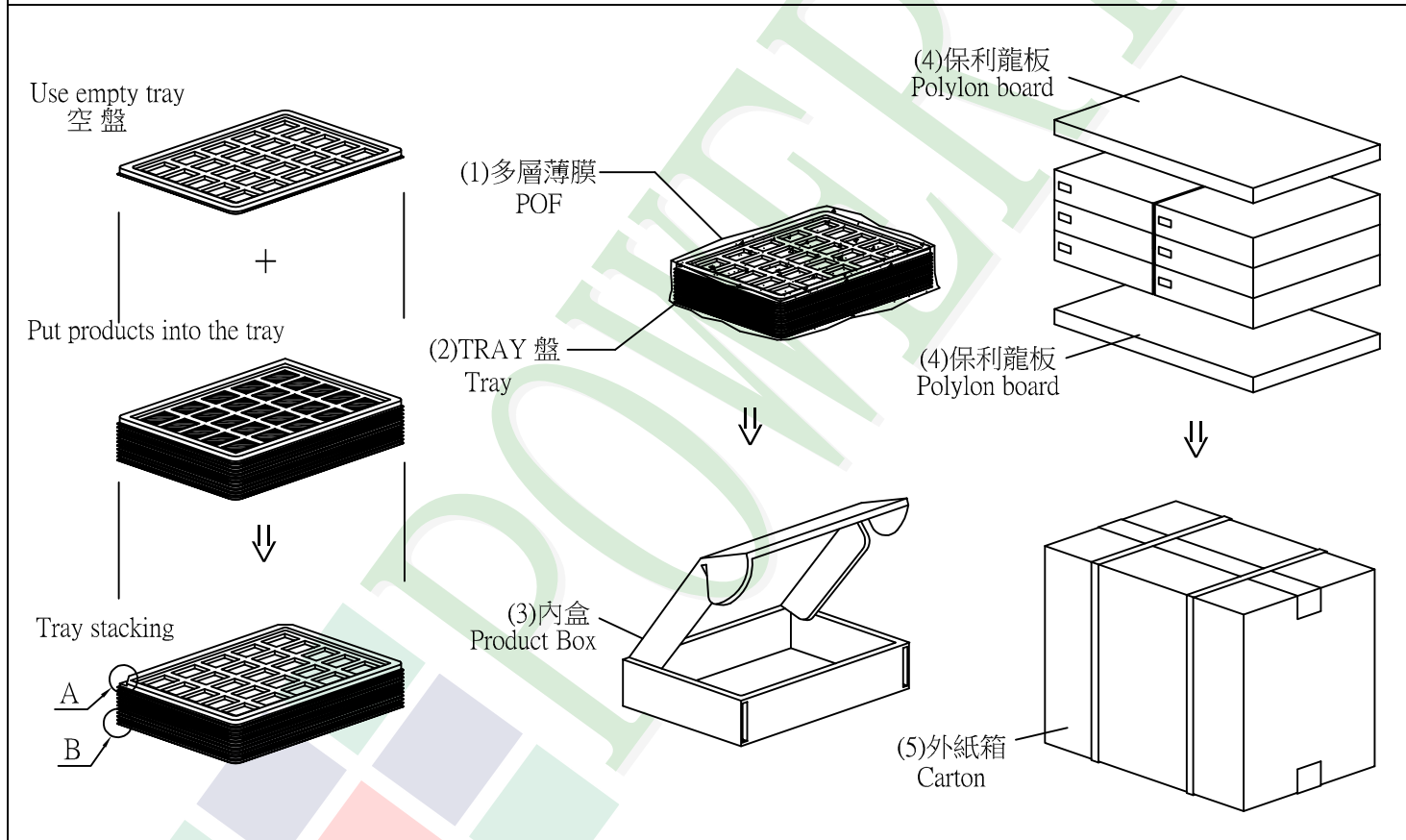
1.包裝材料規格表 (Packaging Material) : (per carton)

No.	Item	Model	Dimensions (mm)	1Pcs Weight	Quantity	Total Weight
1	成品 (LCM)	PH240320T075-ZEA	50.0X69.2X2.45	0.0116	576	6.6816
2	多層薄膜(1)POF	OTFILM0BA03ABA	19"X350X0.015	——	6	——
3	TRAY 盤 (2)Tray	TYSG000000197	352 X 260 X 11.6	0.08432	54	4.5533
4	內盒(3)Product Box	BX36627063ABBA	383 X 270 X 66	0.182	6	1.092
5	保利龍板(4)Polylon board	OTPLB00PL08ABA	550 X 393 X 20	0.0284	2	0.0568
6	外紙箱(5)Carton	BX57041027CCBA	570 X 410 X 265	1.0	1	1.0
7						
8						
9						

2.一 整箱總重量 (Total LCD Weight in carton) : 13.38 Kg±10%

3.單箱數量規格表 (Packaging Specifications and Quantity) :

(1)LCM quantity per box : no per tray	12	x no of tray	8	=	96
(2)Total LCM quantity in carton : quantity per box	96	x no of boxes	6	=	576



特 記 事 項 (REMARK)

4. TRAY盤相疊時,需旋轉180度,請詳見B視圖 Rotate tray 180 degrees and place on top of stack. Check the tray stack using Fig. B.		
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